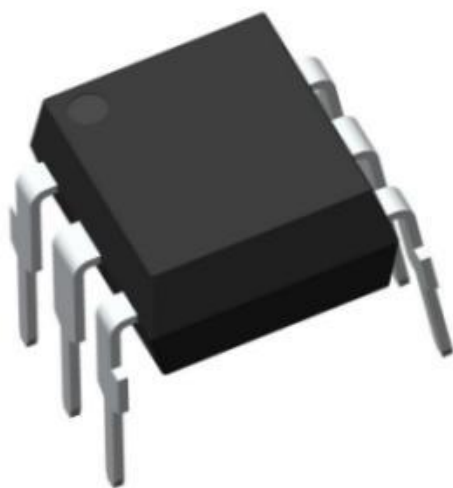




晶体管光耦 Photo Transistor

AT4NXX

Product Data Sheet

AOTE DCC
RELEASE

台湾奥特半导体科技有限公司

TAIWAN AOTE SEMICONDUCTOR TECHNOLOGY CO.,LTD

www.aotesemi.com

概述 Description

AT4NXX是一款由发光二极管和一个光电晶体管组成的光电耦合器。六引脚封装 (DIP6、SMD6)。

The AT4NXX is a photoelectric coupler composed of light-emitting diode and phototransistor. It is packaged in a 6-pin package at DIP、SMD.

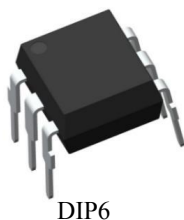
特性 Features

- 电流转换比(CTR)范围: $\geq 20\%$ ($I_F = 10\text{mA}$, $V_{CE} = 10\text{V}$, $T_a = 25^\circ\text{C}$) Current transfer ratio: $\geq 20\%$ ($I_F = 10\text{mA}$, $V_{CE} = 10\text{V}$, $T_a = 25^\circ\text{C}$)
- 输入-输出隔离电压 ($V_{ISO} = 5000\text{ Vrms}$)
High isolation voltage between input and output ($V_{ISO} = 5000\text{ Vrms}$)
- 输入-输出隔离电阻 (典型值 $R_{ISO} = 10^{11}\Omega$)
Input-output isolation voltage resistance ($R_{ISO} = 10^{11}\Omega$)
- 工作温度: $-55^\circ\text{C} \sim 100^\circ\text{C}$
Operating Temperature: $-55^\circ\text{C} \sim 100^\circ\text{C}$
- 符合加强绝缘标准
Meet reinforced insulation standards
- 符合安规标准: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022
Meet safety standard approval: UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022

应用 Applications

- 电源调节器
Power regulator
- 数字逻辑输入
Digital logic input
- 微处理器输入
Microprocessor input

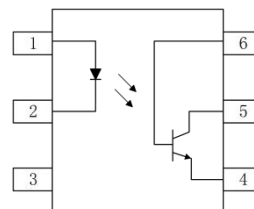
封装和原理图 Package and Schematic Diagram



DIP6



SMD6



Pin Configuration

1. Anode
2. Cathode
3. NC
4. Emitter
5. Collector
6. Base

产品型号命名规则 Order Code

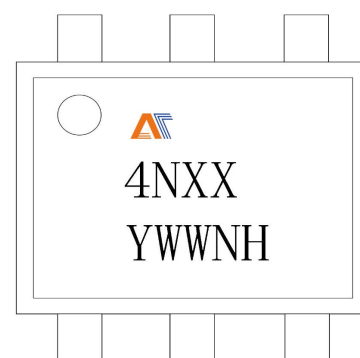
AT 4NXX - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦

- ① 公司代码 Company Code (AT: 奥特AOTE)
- ② 产品系列 Product Series (XX: 25, 26, 27,28,35,36,37,38)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (D: DIP ; S: SMD)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range or None)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中 “” 为奥特品牌 LOGO
 “” denotes LOGO
- 印字中的 “XX” 代表产品分档 : 25, 26, 27,28,35,36,37,38
 “XX” denotes the classification : 25, 26, 27,28,35,36,37,38
- 印字中 “Y” 代表年份 ; A(2018),B(2019),C(2020).....
 “Y” denotes YEAR : A(2018), B(2019), C(2020).....
- 印字中 “WW” 代表周号
 “WW” denotes Week' s number
- 印字中 “E” 代表产品版本号
 “E” denotes product versions
- 印字中的 “H” 代表无卤
 “H” denotes Halogen-free



绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Remark
爬电距离 Creepage Distance	L	>7.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body
电气间隙 Clearance Distance	L	>7.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air
绝缘距离 Insulation Thickness	DTI	> 0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector
峰值隔离电压 Peak Isolation Voltage	V _{IORM}	1500	V _{peak}	DIN/EN/IEC EN60747-5-5
瞬态隔离电压 Transient isolation voltage	V _{IOTM}	7000	V _{peak}	DIN/EN/IEC EN60747-5-5
隔离电压 Isolation Voltage	V _{iso}	>5000	V _{rms}	For 1 min , RH < 60%

极限参数 Absolute Maximum Ratings (Ta = 25°C)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	I _F	60	mA
	峰值正向电流(1us, 脉冲) Peak forward current (1us, pulse)	I _{FP}	1000	mA
	反向电压 Reverse Voltage	V _R	6	V
	功耗 Power Dissipation	P _D	100	mW
接收端 output	集电极功耗 Collector Power Dissipation	P _C	300	mW
	集电极电流 Collector Current	I _C	100	mA
	集电极-基极电压 Collector-Base Voltage	V _{CBO}	70	V
	集电极-发射极电压 Collector-Emitter Voltage	V _{CEO}	30	V
	发射极-集电压 Emitter - Collector Voltage	V _{ECO}	7	V
总功耗 Total Power Dissipation		P _{tot}	350	mW
输入输出瞬态耐受电压 Input-output isolation voltage		V _{iso}	5000	V _{rms}
工作温度 Operating Temperature		T _{opr}	-55~+100	°C
存储温度 Storage Temperature		T _{stg}	-55~+125	°C
焊接温度 Soldering Temperature		T _{sol}	260	°C

产品特性参数 Electro-optical Characteristics (Ta = 25℃)

参数 Parameter			符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage		V _F	I _F =10mA	-	1.2	1.5	V
	反向电流 Reverse Current		I _R	V _R =3V	-	-	10	μA
	输入电容 Terminal Capacitance		C _t	V=0, F=1KHz	-	50	-	pF
接收端 Output	集电极暗电流 Collector Dark Current		I _{CEO}	V _{CE} =10V	-	-	50	nA
	集电极-基极击穿电压 Collector-Base Breakdown Voltage		BV _{CBO}	I _B =0.1mA, I _F =0	70	-	-	V
	集电极-发射极击穿电压 Collector-Emitter Breakdown Voltage		BV _{CEO}	I _C =0.1mA, I _F =0	30	-	-	V
	发射极-集电极击穿电压 Emitter-Collector Breakdown Voltage		BV _{ECO}	I _E =0.01mA, I _F =0	7	-	-	V
传输特性 Transfer Characteristics	电流传输比 Current Transfer Ratio	4N25、4N26、4N38	CTR [*]	I _F =10mA ,V _{CE} =10V	20	-	-	%
		4N27、4N28			10	-	-	%
		4N35、4N36、4N37			100	-	-	%
	集电极-发射极饱和压降 Collector-Emitter Saturation Voltage		V _{CE(sat)}	I _F =50mA,I _C =2mA	-	-	0.3	V
	隔离电阻 Isolation Resistance		R _{ISO}	DC=500V 40~60%R.H.	5x10 ¹⁰	1x10 ¹¹	-	Ω
	隔离电容 Isolation capacitance		C _{ISO}	V=0,F=1MHz	-	1	2.5	pF
	上升时间 Rise Time		T _r	V _{CE} =10V, I _C =2mA, R _L =100Ω	-	4	-	μs
	下降时间 Fall Time		T _f		-	3	-	μs

注*：电流传输比= $I_C/I_F \times 100\%$ 。

Note*：CTR= $I_C/I_F \times 100\%$ 。

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 Relative Current Transfer Ratio vs. Forward Current

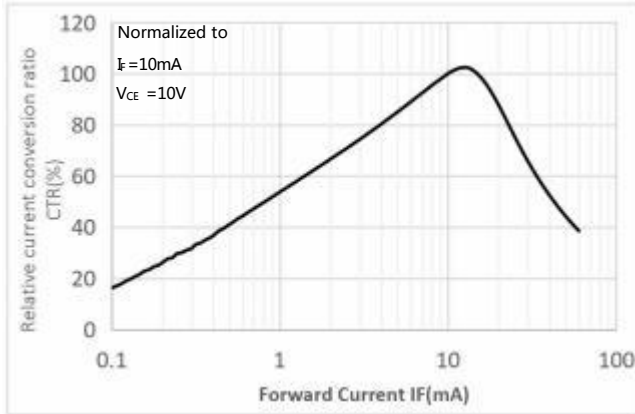


Fig.2 Forward Current vs. Forward Voltage

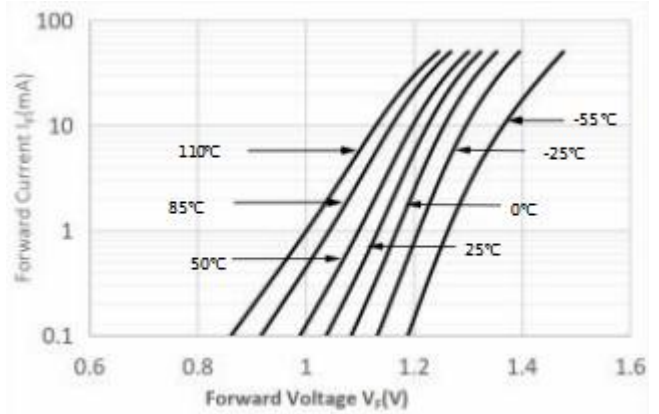


Fig.3 Collector Current vs. Collector-emitter Voltage

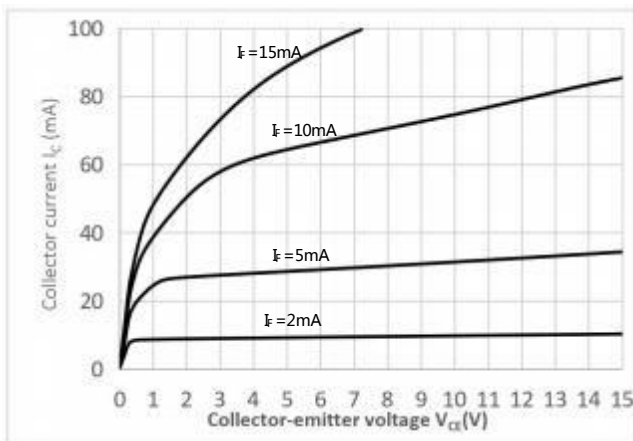


Fig.4 Relative Current Transfer Ratio vs. Ambient Temperature

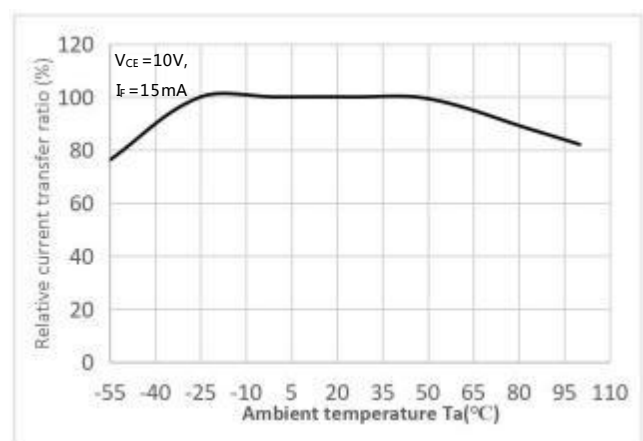


Fig.5 Collector Dark Current vs Ambient Temperature

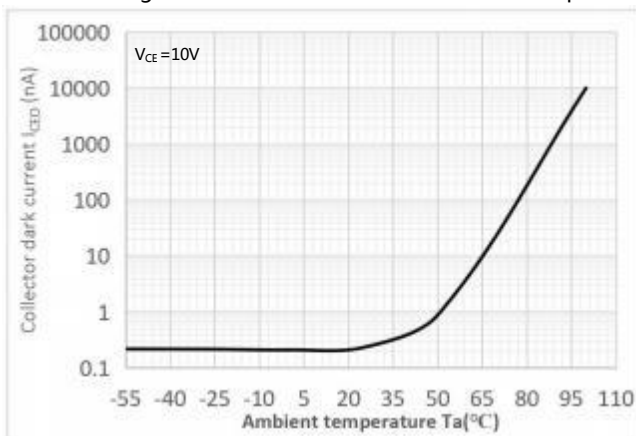


Fig.6 Response Time vs. Load Resistance

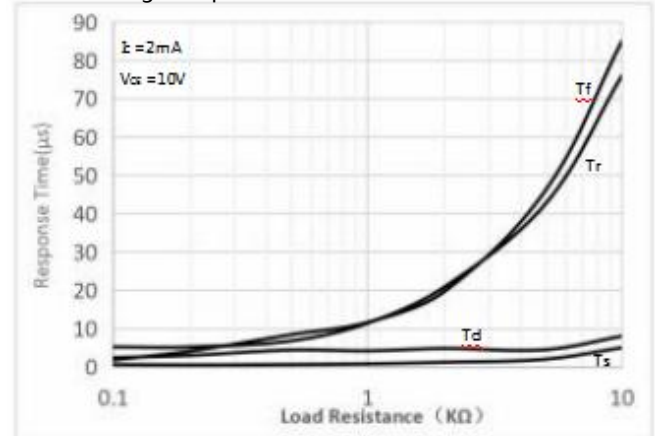


Fig.7 Frequency Response

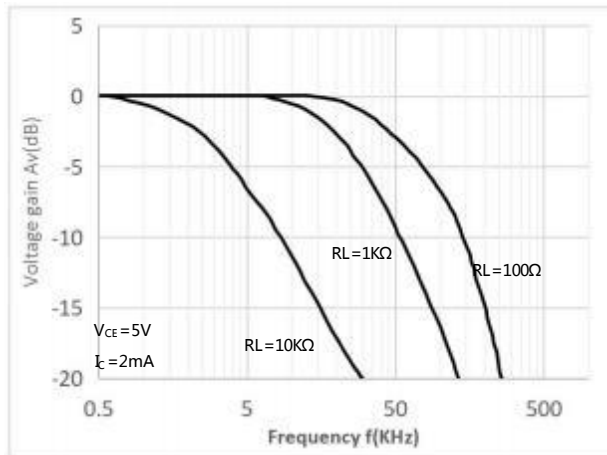


Fig.8 Collector-emitter Saturation Voltage vs Forward Current

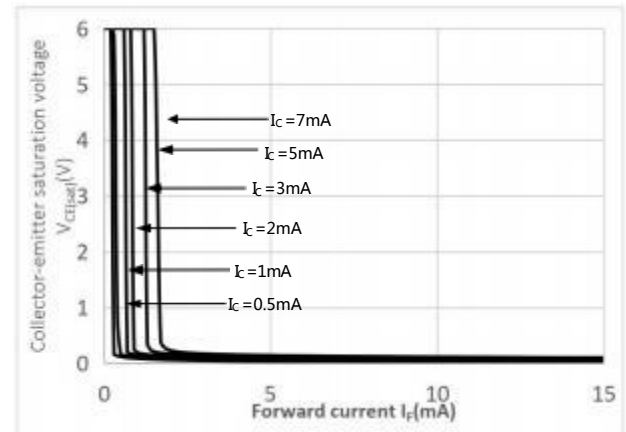
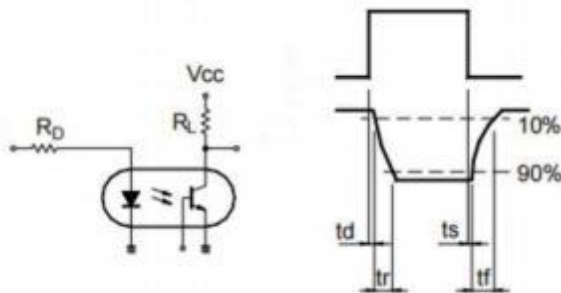
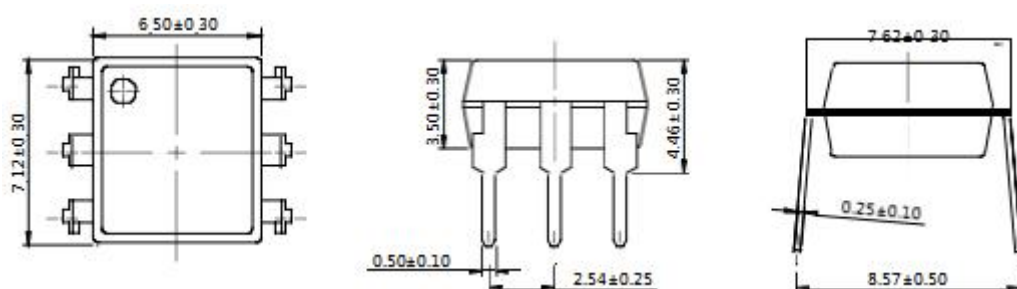


Fig.9 Switching Time Test Circuit & Waveforms

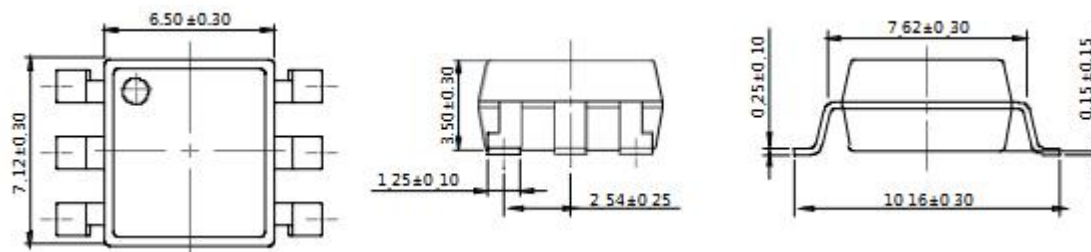


外形尺寸 Outline Dimensions

DIP6

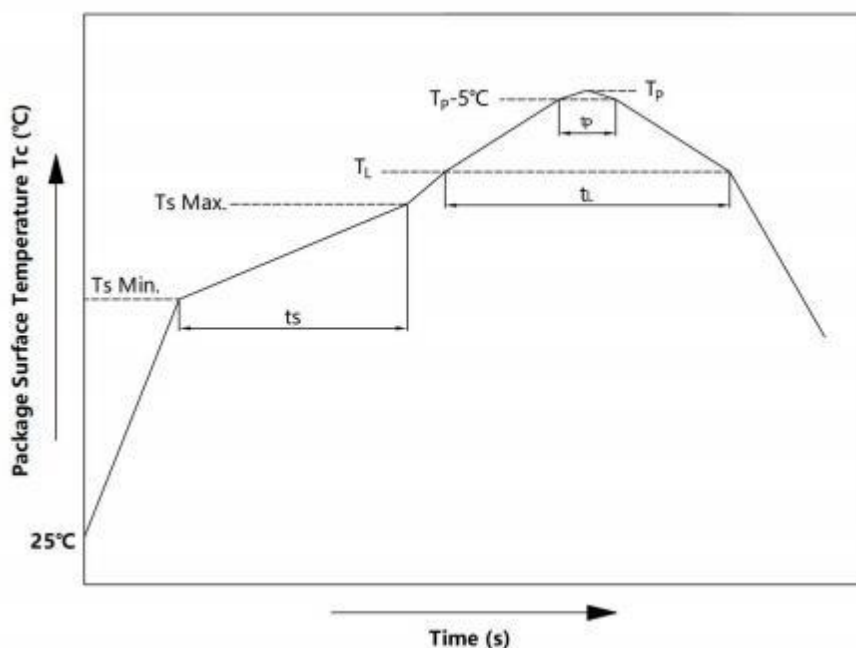


SMD6



单位 Unit: mm

回流焊温度曲线图 Solder Reflow Profile



项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	Ts	150	200	°C
预热时间 Preheat Time	ts	60	120	s
升温速率 Ramp-Up Rate (TL to TP)	-	-	3	°C/s
液相线温度 Liquidus Temperature	TL	217		°C
时间高于 TL Time Above TL	tL	60	150	s
峰值温度 Peak Temperature	TP	-	260	°C
Tc 在 (TP-5) 和 TP 之间的时间 Time During Which Tc Is Between (TP-5) and TP	tp	-	30	s
降温速率 Ramp-down Rate (TP to TL)	-	-	6	°C/s

注 Note :

建议在所示的温度和时间条件下进行回流焊，最多不能超过三次；

Reflow soldering is recommended at the temperatures and times shown, no more than three times;

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

- A. 手工烙铁焊仅用于产品返修或样品测试；
Hand soldering iron is only used for product rework or sample testing;
- B. 手工烙铁焊要求：温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ，时间 $\leq 3\text{s}$ 。
Manual soldering method Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

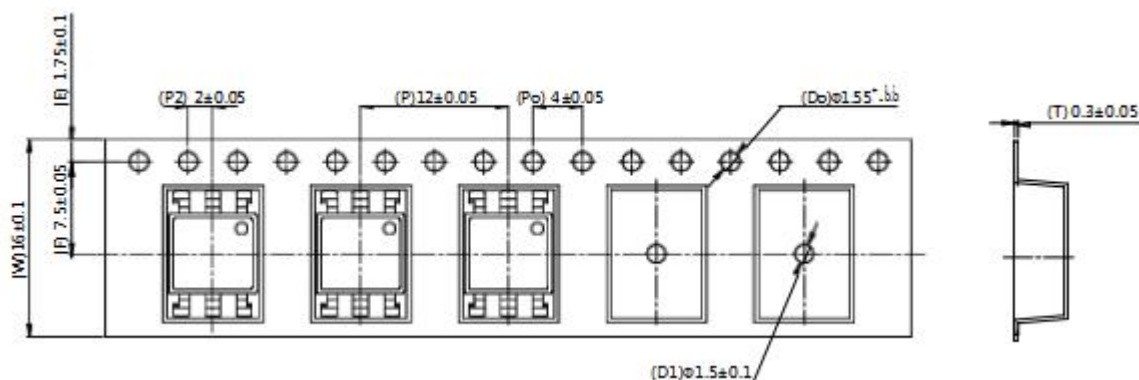
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SMD6	卷盘 ($\phi 330$ mm 蓝盘)	1000 只/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	340*60*340mm	620*360*365mm	首尾端空至少 200mm
DIP6	管装 (500*12*11mm)	65 只/管	50 管/盒	10 盒/箱	不适用	525*128*56mm	535*275*300mm	每管使用蓝白胶塞, 方向须一致
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SMD6	Reel ($\phi 330$ mm Blue)	1000 pcs/reel	2 reels/box	10 boxes/ctn	450*390*0.1mm	340*60*340mm	620*360*365mm	Guard band 200mm min.
DIP6	Tube (500*12*11mm)	65 pcs/tube	50 tubes/box	10 boxes/ctn	NA	525*128*56mm	535*275*300mm	Endplug (blue) and Endplug (white) keep the direction

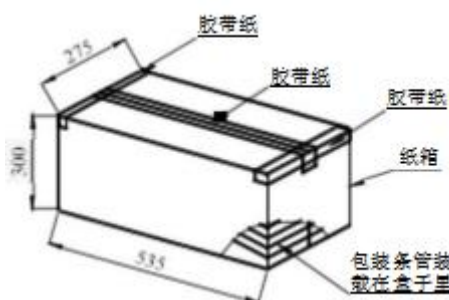
■ 编带包装 Tape & Reel

- 1) 每卷数量：1000 只。
Qty/reel : 1000 pcs.
- 2) 每箱数量：20000 只。
Qty/ctn : 20000 pcs.
- 3) 内包装：每盒 2 盘。
Inner packing : 2 reels/box.
- 4) 示意图 Schematic :



■ 管条包装 Tape & Tube

- 1) 每管数量：65 只。
Qty/Tube : 65 pcs.
- 2) 每箱数量：32500 只。
Qty/ctn : 32500 pcs.
- 3) 内包装：每盒 50 管。
Inner packing : 50 Tube/box.
- 4) 示意图 Schematic



单位/Unit : mm

注意 Attention

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